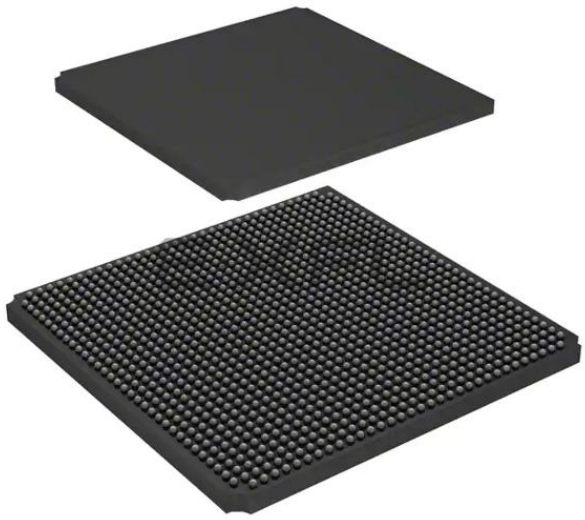
Lattice Semiconductor Corporation - LFE2M100SE-7F1152C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	520
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100se-7f1152c

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

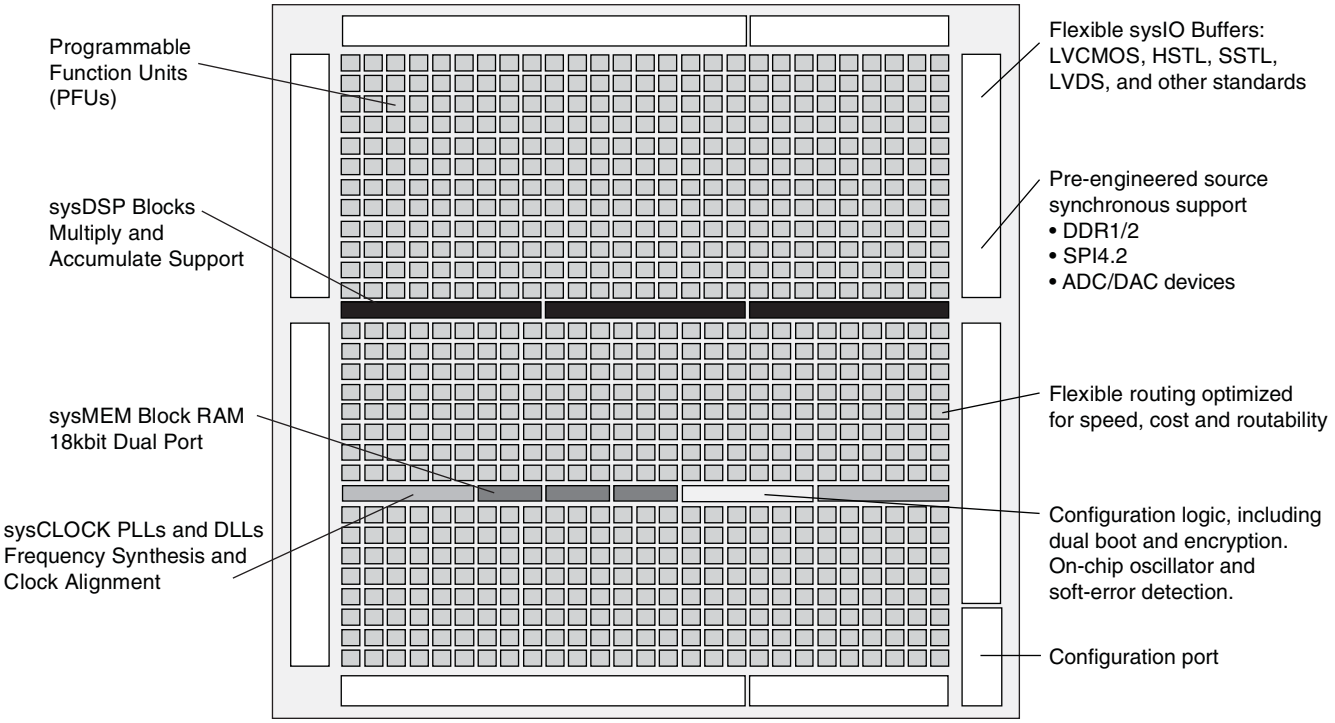


Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)

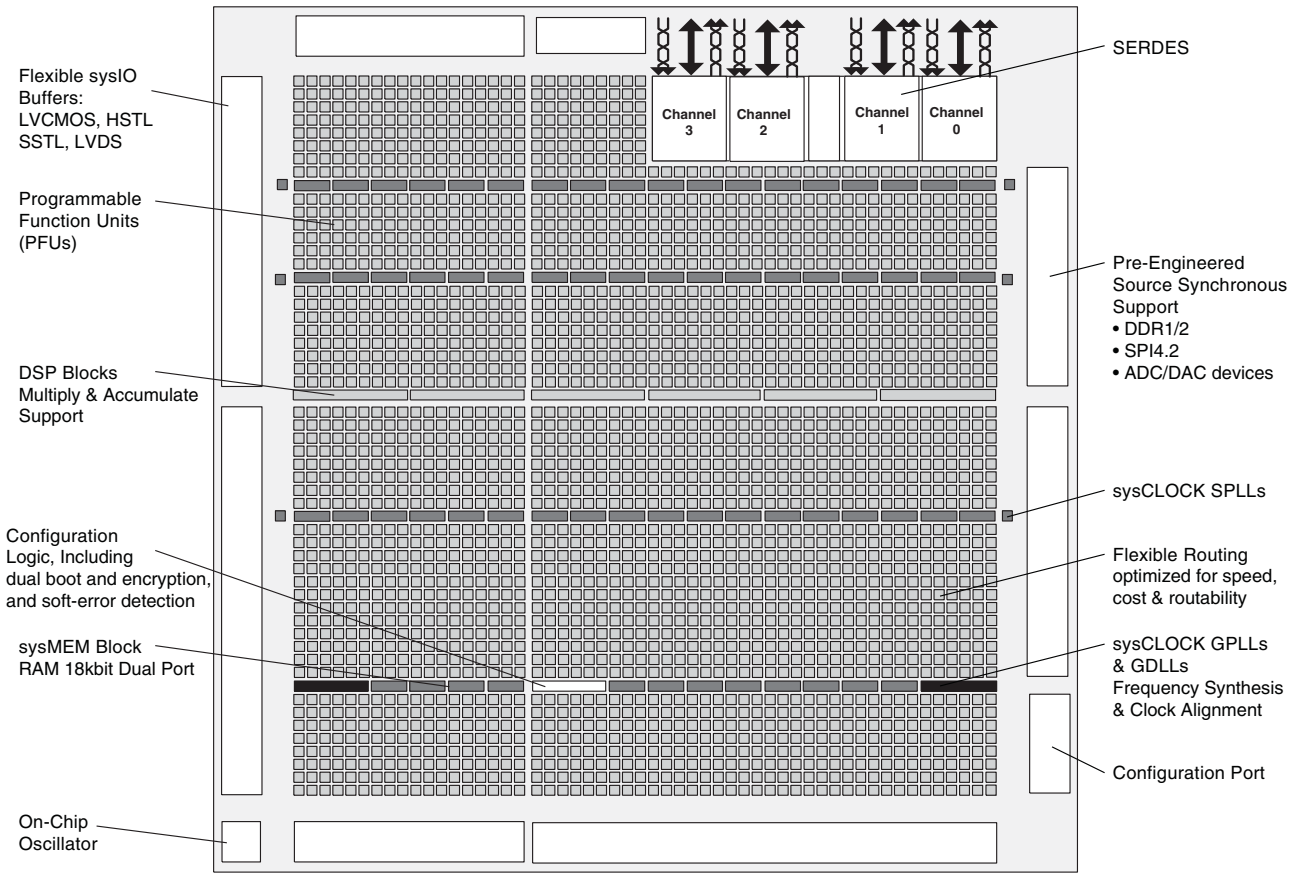
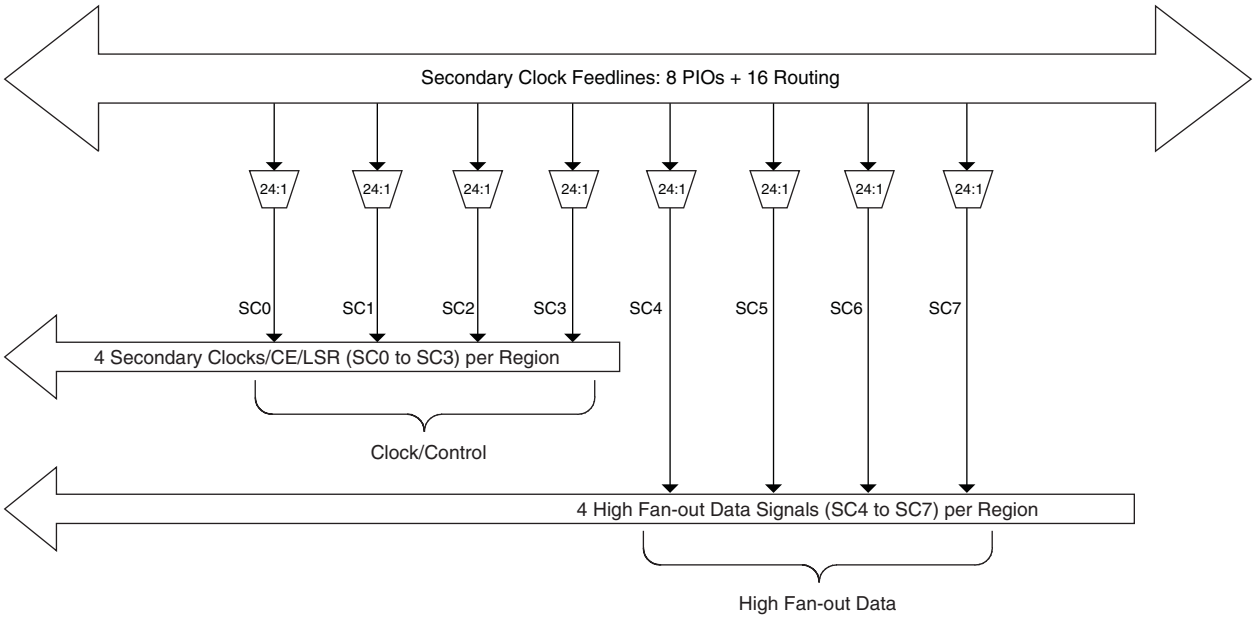


Figure 2-16. Secondary Clock Selection

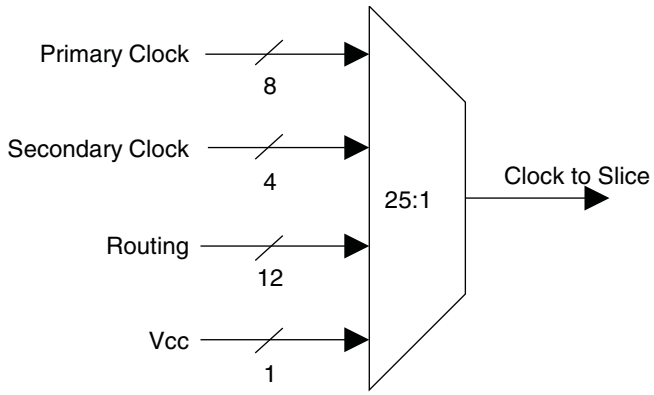


Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection



LatticeECP2/M Family Data Sheet DC and Switching Characteristics

September 2013 Data Sheet DS1006

Absolute Maximum Ratings[1, 2, 3]

Supply Voltage V_{CC} . . . . . -0.5 to 1.32V

Supply Voltage V_{CCAUX} . . . . . -0.5 to 3.75V

Supply Voltage V_{CCJ} . . . . . -0.5 to 3.75V

Output Supply Voltage V_{CCIO} . . . . . -0.5 to 3.75V

Input or I/O Tristate Voltage Applied[4]. . . . . -0.5 to 3.75V

Storage Temperature (Ambient) . . . . . -65 to 150°C

Junction Temperature (Tj) . . . . . +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice Thermal Management document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to (V_{IHMAX} + 2) volts is permitted for a duration of <20ns.

Recommended Operating Conditions[7]

Symbol	Parameter	Min.	Max.	Units
V_{CC}[1, 4, 5]	Core Supply Voltage	1.14	1.26	V
V_{CCAUX}[1, 3, 4, 5]	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
V_{CCIO}[1, 2, 4]	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}[1]	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCRX}[6]	Receive Power Supply	1.14	1.26	V
V_{CCTX}[6]	Transmit Power Supply	1.14	1.26	V

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{SU_DEL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.40	—	1.70	—	1.90	—	ns
		LFE2M70	1.40	—	1.70	—	1.90	—	ns
		LFE2M100	1.40	—	1.70	—	1.90	—	ns
t_{H_DEL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f_{MAX_IO}	Clock Frequency of I/O Register and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Edge Clock without PLL)[1]									
t_{COE}	Clock to Output - PIO Output Register	LFE2-6	—	2.60	—	2.90	—	3.20	ns
		LFE2-12	—	2.60	—	2.90	—	3.20	ns
		LFE2-20	—	2.60	—	2.90	—	3.20	ns
		LFE2-35	—	2.60	—	2.90	—	3.20	ns
		LFE2-50	—	2.60	—	2.90	—	3.20	ns
		LFE2-70	—	2.60	—	2.90	—	3.20	ns
		LFE2M20	—	2.60	—	2.90	—	3.20	ns
		LFE2M35	—	2.60	—	2.90	—	3.20	ns
		LFE2M50	—	3.10	—	3.40	—	3.70	ns
		LFE2M70	—	3.10	—	3.40	—	3.70	ns
		LFE2M100	—	3.10	—	3.40	—	3.70	ns

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}[1]	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}[2]	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}[3]	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.
2. CLKOS minimum frequency is obtained with divide by 4.
3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

SERDES High Speed Data Receiver (LatticeECP2M Family Only)

Table 3-11. Serial Input Data Specifications

Symbol	Description	Min.	Typ.	Max.	Units
$RX\text{-}CID_S$	Stream of nontransitions[1] (CID = Consecutive Identical Digits) @ 10^{-12} BER		7 @ 3.125 Gbps 20 @ 1.25 Gbps		Bits
$V_{RX\text{-}DIFF\text{-}S}$	Differential input sensitivity	100	—	—	mV, p-p
$V_{RX\text{-}IN}$	Input levels	0	—	V_{CCRX} + 0.8	V
$V_{RX\text{-}CM\text{-}DC}$	Input common mode range (DC coupled)	0.5	—	1.2	V
$V_{RX\text{-}CM\text{-}AC}$	Input common mode range (AC coupled)[3]	0	—	1.5	V
$T_{RX\text{-}RELOCK}$	CDR re-lock time[2]	—	—	3000	Bits
$Z_{RX\text{-}TERM}$	Input termination 50/75 Ohm/High Z	—	50		Ohms
$RL_{RX\text{-}RL}$	Return loss (without package)	—	9	—	dB

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification[1]

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	600 mV differential eye	—	—	0.54	UI, p-p
Random		600 mV differential eye	—	—	0.26	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	2.5 Gbps	600 mV differential eye	—	—	0.61	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.81	UI, p-p
Deterministic	1.25 Gbps	600 mV differential eye	—	—	0.53	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	250 Mbps[2]	600 mV differential eye	—	—	0.42	UI, p-p
Random		600 mV differential eye	—	—	0.10	UI, p-p
Total		600 mV differential eye	—	—	0.60	UI, p-p

1. Values are measured with PRBS 2^7-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		131	193	331	402	331	450
Differential Pair User I/O		62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60	68
	Dedicated Pins	3	3	3	3	3	3
VCC		14	7	18	24	16	22
VCCAUX		8	4	16	16	16	16
VCCPLL		0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4	5
	Bank1	2	2	4	5	4	5
	Bank2	2	2	4	5	4	5
	Bank3	2	2	4	5	4	5
	Bank4	2	2	4	5	4	5
	Bank5	2	2	4	5	4	5
	Bank6	2	2	4	5	4	5
	Bank7	2	2	4	5	4	5
	Bank8	2	1	2	2	2	2
GND, GND0 to GND7		22	20	60	72	60	72
NC		0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25	67/33
	Bank1	18/9	34/17	46/23	52/26	46/23	52/26
	Bank2	11/5	20/10	34/17	36/18	34/17	48/24
	Bank3	11/5	12/6	22/11	32/16	22/11	42/21
	Bank4	19/9	32/16	46/23	50/25	46/23	54/27
	Bank5	18/9	17/8	46/23	68/34	46/23	68/34
	Bank6	18/8	26/13	40/20	48/24	40/20	58/29
	Bank7	12/6	20/10	33/16	35/17	33/16	47/23
	Bank8	6/2	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5	9
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10	13
	Bank7 (Left Edge)	5	5	8	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0	0

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank[1]	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	1	0	1	3
	Bank3	0	1	0	1	2
	Bank4	2	4	2	4	3
	Bank5	1	2	1	2	3
	Bank6	0	3	0	1	2
	Bank7	1	2	1	2	3
	Bank8	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	0	0	0	0
	Bank3	0	0	0	0	0
	Bank4	32	62	32	62	50
	Bank5	20	28	20	28	60
	Bank6	16	40	16	39	52
	Bank7	28	40	28	40	60
	Bank8	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Single Ended User I/O		270	372	410	416	436	416	520
Differential Pair User I/O		135	185	205	208	218	207	260
Configuration	TAP Pins	5	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7	7
Non Configuration	Muxed Pins	69	72	72	75	76	74	78
	Dedicated Pins	3	3	3	3	3	3	3
VCC		16	20	62	44	44	44	44
VCCAUX		8	26	18	16	12	16	12
VCCPLL		4	8	4	4	4	4	4
VCCIO	Bank0	4	5	6	6	7	6	7
	Bank1	3	4	6	6	7	6	7
	Bank2	4	5	9	9	9	9	9
	Bank3	4	5	9	9	9	9	9
	Bank4	4	4	6	6	7	6	7
	Bank5	4	5	6	6	7	6	7
	Bank6	4	5	9	9	9	9	9
	Bank7	4	5	9	9	9	9	9
	Bank8	2	2	2	2	2	2	2
GND, GND0 to GND7		57	80	122	122	134	122	134
NC		31	35	121	63	283	63	199
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	36/18	63/31	56/28	34/17	46/23	34/17	54/27
	Bank1	18/9	18/9	36/18	42/21	34/17	42/21	44/22
	Bank2	30/15	50/25	54/27	70/35	72/36	70/35	80/40
	Bank3	36/18	43/21	44/22	60/30	64/32	60/30	80/40
	Bank4	42/21	24/12	38/19	38/19	40/20	38/19	44/22
	Bank5	28/14	60/30	58/29	40/20	40/20	40/20	46/23
	Bank6	40/20	54/27	60/30	62/31	66/33	62/31	82/41
	Bank7	40/20	60/30	64/32	70/35	74/37	70/35	90/45
	Bank8	0/0	0/0	0/0	0/0	0/0	0/0	0/0
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0	0
	Bank2 (Right Edge)	7	12	13	17	18	17	20
	Bank3 (Right Edge)	9	11	11	15	16	15	20
	Bank4 (Bottom Edge)	0	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0	0
	Bank6 (Left Edge)	10	14	15	15	16	15	20
	Bank7 (Left Edge)	10	15	17	17	18	17	22
	Bank8 (Right Edge)	0	0	0	0	0	0	0

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C2	PT3A	0		T	PT3A	0		T
J10	VCC	-			VCC	-		
J11	VCC	-			VCC	-		
J12	VCC	-			VCC	-		
J13	VCC	-			VCC	-		
K14	VCC	-			VCC	-		
K9	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L9	VCC	-			VCC	-		
M14	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N9	VCC	-			VCC	-		
P10	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P12	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
G10	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
H9	VCCIO0	0			VCCIO0	0		
H8	VCCIO0	0			VCCIO0	0		
G11	VCCIO1	1			VCCIO1	1		
G12	VCCIO1	1			VCCIO1	1		
G13	VCCIO1	1			VCCIO1	1		
G14	VCCIO1	1			VCCIO1	1		
H14	VCCIO2	2			VCCIO2	2		
H15	VCCIO2	2			VCCIO2	2		
J15	VCCIO2	2			VCCIO2	2		
K16	VCCIO2	2			VCCIO2	2		
L16	VCCIO3	3			VCCIO3	3		
M16	VCCIO3	3			VCCIO3	3		
N16	VCCIO3	3			VCCIO3	3		
P16	VCCIO3	3			VCCIO3	3		
R14	VCCIO4	4			VCCIO4	4		
T12	VCCIO4	4			VCCIO4	4		
T13	VCCIO4	4			VCCIO4	4		
T14	VCCIO4	4			VCCIO4	4		
R9	VCCIO5	5			VCCIO5	5		
T10	VCCIO5	5			VCCIO5	5		
T11	VCCIO5	5			VCCIO5	5		
T9	VCCIO5	5			VCCIO5	5		
N7	VCCIO6	6			VCCIO6	6		
P7	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AE17	PB51B	4	BDQ51	C	PB51B	4	BDQ51	C
AB19	PB52A	4	BDQ51	T	PB52A	4	BDQ51	T
AE19	PB52B	4	BDQ51	C	PB52B	4	BDQ51	C
AF17	PB53A	4	BDQ51	T	PB53A	4	BDQ51	T
AE18	PB53B	4	BDQ51	C	PB53B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
W16	PB54A	4	BDQ51	T	PB54A	4	BDQ51	T
AA17	PB54B	4	BDQ51	C	PB54B	4	BDQ51	C
AF18	PB55A	4	BDQ51	T	PB55A	4	BDQ51	T
AF19	PB55B	4	BDQ51	C	PB55B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
AA19	NC	-			PB56A	4	BDQ60	T
W17	NC	-			PB56B	4	BDQ60	C
Y19	NC	-			PB57A	4	BDQ60	T
Y17	NC	-			PB57B	4	BDQ60	C
AF20	NC	-			NC	-		
VCCIO	VCCIO4	4			VCCIO4	4		
AE20	NC	-			NC	-		
AA20	NC	-			NC	-		
W18	NC	-			NC	-		
AD20	NC	-			NC	-		
GND	GNDIO4	-			GNDIO4	-		
AE21	NC	-			NC	-		
AF21	NC	-			NC	-		
AF22	NC	-			NC	-		
VCCIO	VCCIO4	4			VCCIO4	4		
GND	GNDIO4	-			GNDIO4	-		
AE22	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T
AD22	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C
AF23	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T
AE23	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C
AD23	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T
AC23	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
AB20	PB59A	4	BDQ60	T	PB68A	4	BDQ69	T
AC20	PB59B	4	BDQ60	C	PB68B	4	BDQ69	C
GND	GNDIO4	-			GNDIO4	-		
AB21	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T
AC22	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C
W19	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T
AA21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C
AF24	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T
AE24	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
Y20	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T
AB22	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U24	PR30B	3	RLM0_GPLLC_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLLC_IN_A**/RDQ48	C (LVDS)*
U25	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLLT_IN_A**/RDQ48	T (LVDS)*
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
P18	VCC	3			VCCPLL	3		
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T
GND	GNDIO3	-			GNDIO3	-		
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T
VCCIO	VCCIO3	3			VCCIO3	3		
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*
R22	NC	-			PR38B	3	RDQ39	C
GND	GNDIO3	-			GNDIO3	-		
T21	NC	-			PR38A	3	RDQ39	T
P26	NC	-			NC	-		
P25	NC	-			NC	-		
R24	NC	-			NC	-		
VCCIO	VCCIO3	3			VCCIO3	3		
R23	NC	-			NC	-		
P20	NC	-			NC	-		
R19	NC	-			NC	-		
P21	NC	-			PR34B	3	RDQ31	C
GND	GNDIO3	-			GNDIO3	-		
P19	NC	-			PR34A	3	RDQ31	T
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*
N22	NC	-			PR32B	3	RDQ31	C
VCCIO	VCCIO3	3			VCCIO3	3		
R21	NC	-			PR32A	3	RDQ31	T
N26	NC	-			PR31B	3	RDQ31	C (LVDS)*
N25	NC	-			PR31A	3	RDQS31	T (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
N19	PR24B	3	RDQ25	C	PR30B	3	RDQ31	C
N20	PR24A	3	RDQ25	T	PR30A	3	RDQ31	T
M26	PR23B	3	RDQ25	C (LVDS)*	PR29B	3	RDQ31	C (LVDS)*
M25	PR23A	3	RDQ25	T (LVDS)*	PR29A	3	RDQ31	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
N18	PR22B	3	VREF2_3/RDQ25	C	PR28B	3	VREF2_3/RDQ31	C
N21	PR22A	3	VREF1_3/RDQ25	T	PR28A	3	VREF1_3/RDQ31	T
L26	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*
L25	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*
N24	PR19B	2	PCLKC2_0/RDQ16	C	PR25B	2	PCLKC2_0/RDQ22	C
M23	PR19A	2	PCLKT2_0/RDQ16	T	PR25A	2	PCLKT2_0/RDQ22	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	PL24B	7	LDQ24	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*
L1	PL25A	7	LUM0_SPLLT_IN_A/LDQ24	T	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7			VCCIO7	7		
M2	PL25B	7	LUM0_SPLLC_IN_A/LDQ24	C	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
M1	PL26A	7	LUM0_SPLLT_FB_A/LDQ24	T	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N2	PL26B	7	LUM0_SPLLC_FB_A/LDQ24	C	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-			GNDIO7	-		
M8	VCCPLL	7			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL37A	7	LDQ41		PL50A	7	LDQ54	
L8	PL38A	7	LDQ41	T	PL51A	7	LDQ54	T
K8	PL38B	7	LDQ41	C	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL39A	7	LDQ41	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
K5	PL39B	7	LDQ41	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
L7	PL40A	7	LDQ41	T	PL53A	7	LDQ54	T
L5	PL40B	7	LDQ41	C	PL53B	7	LDQ54	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL41A	7	LDQS41	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
P2	PL41B	7	LDQ41	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
M6	PL42A	7	LDQ41	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL42B	7	LDQ41	C	PL55B	7	LDQ54	C
R1	PL43A	7	LDQ41	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
R2	PL43B	7	LDQ41	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
M7	PL44A	7	PCLKT7_0/LDQ41	T	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL44B	7	PCLKC7_0/LDQ41	C	PL57B	7	PCLKC7_0/LDQ54	C
M4	PL46A	6	PCLKT6_0/LDQ50	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
M5	PL46B	6	PCLKC6_0/LDQ50	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
N7	PL47A	6	VREF2_6/LDQ50	T	PL60A	6	VREF2_6/LDQ63	T
P9	PL47B	6	VREF1_6/LDQ50	C	PL60B	6	VREF1_6/LDQ63	C
N3	PL48A	6	LDQ50	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL48B	6	LDQ50	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
N5	PL49A	6	LDQ50	T	PL62A	6	LDQ63	T
P7	PL49B	6	LDQ50	C	PL62B	6	LDQ63	C
T1	PL50A	6	LDQS50	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	PL50B	6	LDQ50	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
P8	PL51A	6	LDQ50	T	PL64A	6	LDQ63	T
P6	PL51B	6	LDQ50	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	PL52A	6	LDQ50	T (LVDS)*	PL65A	6	LDQ63	T (LVDS)*
P4	PL52B	6	LDQ50	C (LVDS)*	PL65B	6	LDQ63	C (LVDS)*

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W5	PL71B	6	LDQ75	C (LVDS)*	PL84B	6	LDQ88	C (LVDS)*
AC1	PL72A	6	LDQ75	T	PL85A	6	LDQ88	T
AD1	PL72B	6	LDQ75	C	PL85B	6	LDQ88	C
VCCIO	VCCIO6	6			VCCIO6	6		
Y6	PL73A	6	LDQ75	T (LVDS)*	PL86A	6	LDQ88	T (LVDS)*
Y5	PL73B	6	LDQ75	C (LVDS)*	PL86B	6	LDQ88	C (LVDS)*
AE2	PL74A	6	LDQ75	T	PL87A	6	LDQ88	T
AD2	PL74B	6	LDQ75	C	PL87B	6	LDQ88	C
GND	GNDIO6	-			GNDIO6	-		
AB3	PL75A	6	LDQS75	T (LVDS)*	PL88A	6	LDQS88	T (LVDS)*
AB2	PL75B	6	LDQ75	C (LVDS)*	PL88B	6	LDQ88	C (LVDS)*
W7	PL76A	6	LDQ75	T	PL89A	6	LDQ88	T
VCCIO	VCCIO6	6			VCCIO6	6		
W8	PL76B	6	LDQ75	C	PL89B	6	LDQ88	C
Y7	PL77A	6	LDQ75	T (LVDS)*	PL90A	6	LDQ88	T (LVDS)*
Y8	PL77B	6	LDQ75	C (LVDS)*	PL90B	6	LDQ88	C (LVDS)*
AC2	PL78A	6	LDQ75	T	PL91A	6	LDQ88	T
GND	GNDIO6	-			GNDIO6	-		
AD3	PL78B	6	LDQ75	C	PL91B	6	LDQ88	C
AC3	TCK	-			TCK	-		
AA8	TDI	-			TDI	-		
AB4	TMS	-			TMS	-		
AA5	TDO	-			TDO	-		
AB5	VCCJ	-			VCCJ	-		
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GND	GNDIO5	-			GNDIO5	-		
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R19	GND	-		
R20	GND	-		
T11	GND	-		
T12	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T19	GND	-		
T20	GND	-		
U11	GND	-		
U12	GND	-		
U13	GND	-		
U14	GND	-		
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U19	GND	-		
U20	GND	-		
V12	GND	-		
V13	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V18	GND	-		
V19	GND	-		
V28	GND	-		
V3	GND	-		
W12	GND	-		
W13	GND	-		
W14	GND	-		
W15	GND	-		
W16	GND	-		
W17	GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T (LVDS)*
B2	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C(LVDS)*
D3	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T
C2	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C
E4	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T (LVDS)*
VCCIO	VCCIO7	7			VCCIO7	7		
E5	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C(LVDS)*
B1	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T
C1	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C
D2	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO7	-		
D1	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C(LVDS)*
E1	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T
F1	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C
VCCIO	VCCIO7	7			VCCIO7	7		
F3	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T (LVDS)*
F2	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C(LVDS)*
F6	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T
F5	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C
GNDIO	GNDIO7	-			GNDIO7	-		
G4	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
G3	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C(LVDS)*
G1	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
G2	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
H1	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
VCCIO	VCCIO7	7			VCCIO7	7		
J1	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C(LVDS)*
H2	PL14A	7		T	PL14A	7	LDQ15	T
H3	PL14B	7		C	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-			GNDIO7	-		
VCCIO	VCCIO7	7			VCCIO7	7		
G6	PL24A	7	LDQ22	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*
H6	PL24B	7	LDQ22	C (LVDS)*	PL34B	7	LDQ32	C(LVDS)*
J2	PL25A	7	PCLKT7_0/LDQ22	T	PL35A	7	PCLKT7_0/LDQ32	T
GNDIO	GNDIO7	-			GNDIO7	-		
K1	PL25B	7	PCLKC7_0/LDQ22	C	PL35B	7	PCLKC7_0/LDQ32	C
H4	PL27A	6	PCLKT6_0	T (LVDS)*	PL37A	6	PCLKT6_0	T (LVDS)*
H5	PL27B	6	PCLKC6_0	C (LVDS)*	PL37B	6	PCLKC6_0	C(LVDS)*
J4	PL28A	6	VREF2_6	T	PL38A	6	VREF2_6	T
K4	PL28B	6	VREF1_6	C	PL38B	6	VREF1_6	C
VCCIO	VCCIO6	6			VCCIO6	6		
J6	PL31A	6	LLM1_SPLLT_IN_A	T (LVDS)*	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
J5	PL31B	6	LLM1_SPLLC_IN_A	C (LVDS)*	PL41B	6	LLM2_SPLLC_IN_A	C(LVDS)*
K3	PL32A	6	LLM1_SPLLT_FB_A	T	PL42A	6	LLM2_SPLLT_FB_A	T
K2	PL32B	6	LLM1_SPLLC_FB_A	C	PL42B	6	LLM2_SPLLC_FB_A	C
VCCIO	VCCIO6	6			VCCIO6	6		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A7	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C6	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B4	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B3	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A4	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C3	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO1	1		
GNDIO	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
G10	VCCPLL	-			VCCPLL	-		
G7	VCC	-			VCC	-		
G9	VCC	-			VCC	-		
H7	VCC	-			VCC	-		
J10	VCC	-			VCC	-		
K10	VCC	-			VCC	-		
K8	VCC	-			VCC	-		
E7	VCCIO0	0			VCCIO0	0		
VCCIO	VCCIO0	0			VCCIO0	0		
E10	VCCIO1	1			VCCIO1	1		
VCCIO	VCCIO1	1			VCCIO1	1		
E14	VCCIO2	2			VCCIO2	2		
G12	VCCIO2	2			VCCIO2	2		
VCCIO	VCCIO2	2			VCCIO2	2		
K12	VCCIO3	3			VCCIO3	3		
M14	VCCIO3	3			VCCIO3	3		
VCCIO	VCCIO3	3			VCCIO3	3		
M10	VCCIO4	4			VCCIO4	4		
P12	VCCIO4	4			VCCIO4	4		
VCCIO	VCCIO4	4			VCCIO4	4		
M7	VCCIO5	5			VCCIO5	5		
P5	VCCIO5	5			VCCIO5	5		
VCCIO	VCCIO5	5			VCCIO5	5		
K5	VCCIO6	6			VCCIO6	6		
M3	VCCIO6	6			VCCIO6	6		
VCCIO	VCCIO6	6			VCCIO6	6		
E3	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
VCCIO	VCCIO7	7			VCCIO7	7		
T15	VCCIO8	8			VCCIO8	8		
VCCIO	VCCIO8	8			VCCIO8	8		
G8	VCCAUX	-			VCCAUX	-		
H10	VCCAUX	-			VCCAUX	-		
J7	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A15	GND	-			GND	-		
A16	GND	-			GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U21	CS1N***	8		
U17	CSN***	8		
U16	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
T16	D1***	8		
T17	D2***	8		
T22	D3***	8		
GNDIO	GNDIO8	-		
R22	D4***	8		
T15	D5***	8		
R17	D6***	8		
T20	D7/SPID0***	8		
VCCIO	VCCIO8	8		
T21	DI/CSSPI0N***	8		
R21	DOUT/CSON/CSSPI1N***	8		
R20	BUSY/SISPI***	8		
R16	RLM0_PLLCAP	3		
R18	PR65B	3	RLM0_GDLLC_FB_A	C
GNDIO	GNDIO3	-		
R19	PR65A	3	RLM0_GDLLT_FB_A	T
P22	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
P21	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
P16	PR63B	3	RLM0_GPLLC_IN_A**	C
VCCIO	VCCIO3	3		
P17	PR63A	3	RLM0_GPLLT_IN_A**	T
P20	PR62B	3	RLM0_GPLLC_FB_A	C (LVDS)*
P19	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
P18	PR55B	3	RDQ52	C
N16	PR55A	3	RDQ52	T
GNDIO	GNDIO3	-		
N22	PR54B	3	RDQ52	C (LVDS)*
N21	PR54A	3	RDQ52	T (LVDS)*
N17	PR53B	3	RDQ52	C
N18	PR53A	3	RDQ52	T
VCCIO	VCCIO3	3		
M22	PR52B	3	RDQ52	C (LVDS)*
M21	PR52A	3	RDQS52	T (LVDS)*
M16	PR51B	3	RDQ52	C
GNDIO	GNDIO3	-		
M17	PR51A	3	RDQ52	T
M20	PR50B	3	RDQ52	C (LVDS)*

LatticeECP2M Standard Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70